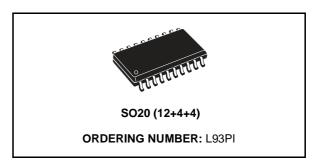




QUAD LOW SIDE DRIVER

- WIDE INPUT VOLTAGE RANGE -24V UP TO +45V
- WIDE OPERATING SUPPLY VOLTAGE RANGE FROM 4.5V UP TO 32V
- REVERSE BIASING PROTECTED (V_S = -24V)
- VERY LOW STANDBY QUIESCENT CURRENT $< 2\mu A$
- PROGRAMMABLE SIGNAL TRANSFER PO-LARITY
- TTL AND CMOS COMPATIBLE INPUTS
- DEFINED OUTPUT OFF STATE OFF FOR OPEN INPUTS
- FOUR OPEN DRAIN DMOS OUTPUTS, WITH $R_{DSon} = 1.5 \Omega$ at 25°C and $V_S > 6V$
- OUTPUT CURRENT LIMITATION
- CONTROLLED OUTPUT SLOPE FOR LOW EMI
- OVERTEMPERATURE SHUT-DOWN
- INTEGRATED OUTPUT CLAMPING FOR FAST INDUCTIVE RECIRCULATION V_{FB} > 45V
- STATUS MONITORING FOR OVERTEMPERATURE

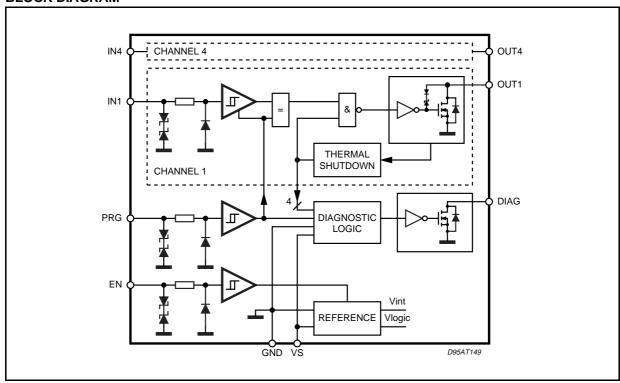


- DISCONNECTED GROUND OR SUPPLY VOLTAGE
- ESD: ALL PINS ARE GUARANTEED TILL 2kV HUMAN BODY MODEL

DESCRIPTION

The L93PI is a monolithic integrated quad low side driver realized in advanced Multipower-BCD technology. It is intended to drive lines, lamps or relais in automotive or industrial applications.

BLOCK DIAGRAM

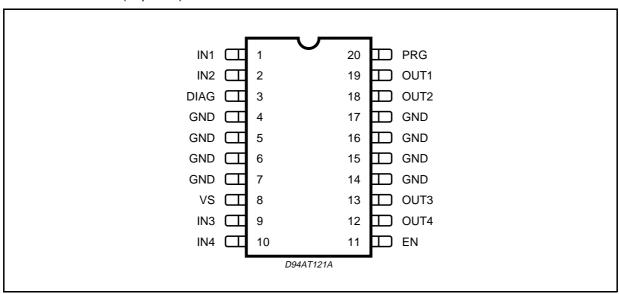


September 2013 1/8

ABSOLUTE MAXIMUM RATINGS (no damage or latch)

| Symbol | Parameter | Value | Unit |
|------------------|----------------------------|------------|------|
| Vs | Supply voltage | -24 to 45 | V |
| Pin voltages | | | |
| V _{IN} | Input, enable, program | -24 to 45 | V |
| V _{OUT} | Output | -0.3 to 45 | V |
| V_{DIAG} | Diagnostic output | -0.3 to 45 | V |
| E _X | Max. Energy During Flyback | 2 | mJ |

PIN CONNECTION (Top view)



PIN DESCRIPTION

| No | Pin Name | Function |
|-------------------------|----------|----------------|
| 8 | VS | SUPPLY VOLTAGE |
| 4,5,6,7,14, 15,16,17 | GND | GROUND |
| 11 | EN | ENABLE |
| 20 | PRG | PROGRAM |
| 3 | DIAG | DIAGNOSTIC |
| 1 | IN1 | INPUT 1 |
| 2 | IN2 | INPUT 2 |
| 9 | IN3 | INPUT 3 |
| 10 | IN4 | INPUT 4 |
| 19 | OUT 1 | OUTPUT 1 |
| 18 | OUT 2 | OUTPUT 2 |
| 13 | OUT 3 | OUTPUT 3 |
| 12 | OUT 4 | OUTPUT 4 |
| _ | NC | NOT CONNECTED |

2/8

THERMAL DATA

| Symbol | Parameter | SO20 (2) | SO(12+4+4) (1) | Unit |
|--------------------------|--|--------------------------|-----------------------|-------|
| R _{th (j-pins)} | Thermal resistance junction to pin | _ | 14 (Typ.) | °C/W |
| R _{th (j-amb)} | Thermal resistance junction to ambient mounted on SMPCB2 board | 77 to 97 | _ | °C/W |
| T _{jMon} | Temperature-monitoring Switch-off-level Switch-on-level | 160 to 190 140 to 170 | | o° o° |

(1) See SGS-THOMSON Microelectronics databook: "Thermal Management in Surface Mount Technology" (2) See SGS-THOMSON Microelectronics databook: "Thermal characteristics of SO20"

| Symbol | Parameter | Value | Unit |
|-----------------------------------|----------------------|------------|------|
| Vs | Supply Voltage | 4.5 to 40 | V |
| V _{IN} | Input pin voltage | -24 to 10 | V |
| V _{EN} | Enable pin voltage | -24 to 45 | V |
| V _{OUT} , V _D | Output pin voltage | -0.3 to 45 | V |
| Tj | Junction temperature | -40 to 150 | °C |

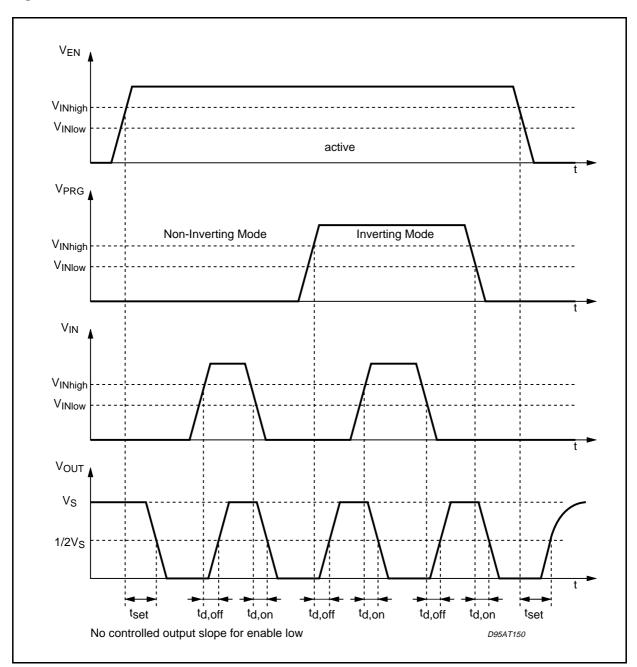
ELECTRICAL CHARACTERISTICS (Refer to the test circuit, unless otherwise specified.)

| Symbol | Parameter | Test Condition | Min. | Тур. | Max. | Unit | |
|---------------------|--------------------------------|--|------|-------|------------|------|--|
| IQ | Quiescent current | $-0.3V \le V_{EN} \le 0.5V;$ $V_S = 14V; T_j = 85^{\circ}C$ | | <2 | 10 | μΑ | |
| | | EN = high; V _S ≤ 14V | | 1.5 | 2 | mA | |
| Inputs IN1 | - IN4, PRG | | | | | | |
| V_{INIlow} | Input voltage LOW | | -24 | | 2.0 | V | |
| V_{INhigh} | Input voltage HIGH | | 2.8 | | 45 | V | |
| I _{IN} | Input current | -24V ≤ Vi ≤ 10V | -10 | | 15 | μΑ | |
| Enable Inpu | ut EN | | | | | | |
| V_{ENlow} | Input voltage LOW | | -24 | | 1 | V | |
| V_{ENhigh} | Input voltage HIGH | | 3.2 | | VS | V | |
| R _{EN} | Input impedance | -24V < V _i < 2.5V | 10 | | | ΚΩ | |
| I _{EN} | Input current | 2.5V ≤ Vi ≤ 25V | | 20 | 50 | μΑ | |
| Outputs Ol | JT1-OUT4 | | | | | | |
| R _{DSon} | Output ON-resistor to ground | $V_S \ge 6V$, $I_O = 0.3A$ $T_j = 25^{\circ}C$ $T_j = 125^{\circ}C$ | | 1.7 | 2.3 3.5 | Ω | |
| I _{OLeak} | Leakage current | $V_O = V_S = 14V; T_j = 85^{\circ}C$ | | ≤1 | 5 | μΑ | |
| V _{OClamp} | Output voltage during clamping | time < 200 μ s; 10mA \leq lo \leq 0.3A | 45 | 52 | 60 | V | |
| losc | Short-circuit current | | 400 | 700 | 1200 | mA | |
| Co | Internal output capacities | V _O ≥ 4.5V | | | 100 | pF | |
| Diagnostic | Diagnostic output DIAG | | | | | | |
| V_{Dlow} | Output voltage LOW | I _{DL} ≤ 1mA | | 0.3 | 0.5 | V | |
| I _{Dmax} | Max. Output current | Internal current limitation | 1 | 5 | 15 | mA | |
| I _{Dleak} | Leakage current | $V_S = 14V; T_J = 85^{\circ}C$ | | ≤ 0.1 | 1 | μΑ | |

ELECTRICAL CHARACTERISTICS (Continued)

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|---------------------|---------------------------------|-------------------------------|------|------|------|------|
| Timing (see | e Fig. 1) | | | | | |
| t _{d,on} | On delay time | $V_S = 14V$, $C_{ext} = 0pF$ | | 2.5 | 3.5 | μs |
| t _{d,off} | Off delay time | 10mA ≤ I _O ≤ 200mA | | 3 | 4.5 | μs |
| t _{set} | Enable settling time | | | | 10 | μs |
| t _{d,DIAG} | On or Off diagnostic delay time | | | | 10 | μs |
| S _{out} | Output slopes | | 2.5 | 9 | 16 | V/µs |

Figure 1



477

CIRCUIT DESCRIPTION

The L93PI is a quad low side driver for lines, lamps or inductive loads in automotive and industrial applications.

All INputs are TTL or CMOS compatible. This allows the device to be driven directly by a microcontroller. For the noise immunity, all inputs have a Schmitt-trigger with a hysteresis of typ. 100mV. Each input stage has an input voltage protection from -24V to 45V. The device can be activated with a 'high' signal on ENable input. ENable 'low' switches the device into the sleep mode. In this mode the quiescent current is less than 10µA. A high signal on PRoGramming input changes the signal transfer polarity from noninverting into the inverting mode. Normally this pin is connected to Vs or GND. These pins (PRG and EN) are internally fixed at low status by open input condition. Independent of the PRoGramming input, the OUTput switches off, if the signal INput pin is not connected.

Each output driver has a current limitation of min 0.4A and a seperate thermal shut-down. The thermal shut-down deactivates that output which ex-

ceeds Temperature switch off level. About 20K below this temperature threshold the output will be activated again. This means, that each output is able to sink continuously 285mA without activating thermal shut-down at 85°C ambient temperature (SO20). The slew rate of the output is limited to max. 14V/µs to reduce the electromagnetic interference, but not for the enable transfer characteristic (see fig. 1). An integrated active flyback voltage limitation clamps the output voltage during the flyback phase of inductive loads to typ. 50V. The power DMOS switches ON, if the device is enabled and the OUTput swings below ground. This protection avoids the activation of parasitics inside the power DMOS.

The DIAGnostic is an open drain output. The logic status depends on the PRoGramming pin. If the PRG pin is 'low' the DIAG output becomes low, if the device works correctly.

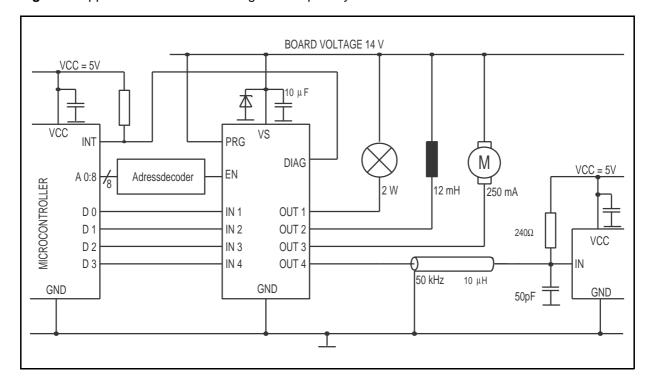
At thermal shut-down of one channel, disconnected ground or supply voltage the DIAGnostic output becomes high. If the PRG pin is 'high' this output is switched off at normal function and switched on at overtemperature.

DIAGNOSTIC TABLE

| Pins | EN | PRG | IN | OUT | DIAG |
|--|----|-----|----|-----------|---------|
| Normal function | Н | L | L | L (on) | L (on) |
| | Н | L | Н | H (off) | L (on) |
| | Н | Н | L | H (off) | H(off) |
| | Н | Н | Н | L (on) | H(off) |
| | L | Х | Х | H (off) | H(off) |
| Overtemperature, disconnected ground or supply voltage | Н | L | X | H (off) * | H (off) |
| Overtemperature | Н | Н | Х | H (off) * | L (on) |

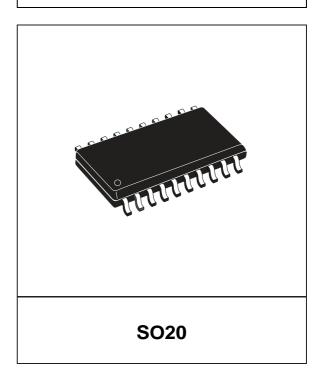
X = not relevant * selective for each channel at overtemperature

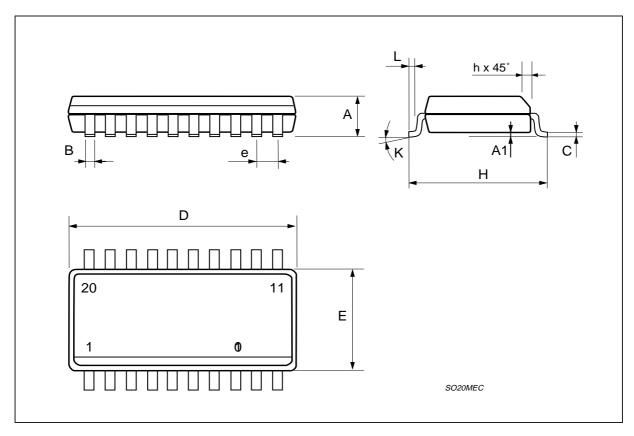
Figure 2: Application circuit for inverting transfer polarity.



| DIM. | mm | | | inch | | | |
|------|--------------------|------|-------|-------|-------|-------|--|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. | |
| Α | 2.35 | | 2.65 | 0.093 | | 0.104 | |
| A1 | 0.1 | | 0.3 | 0.004 | | 0.012 | |
| В | 0.33 | | 0.51 | 0.013 | | 0.020 | |
| С | 0.23 | | 0.32 | 0.009 | | 0.013 | |
| D | 12.6 | | 13 | 0.496 | | 0.512 | |
| Е | 7.4 | | 7.6 | 0.291 | | 0.299 | |
| е | | 1.27 | | | 0.050 | | |
| Н | 10 | | 10.65 | 0.394 | | 0.419 | |
| h | 0.25 | | 0.75 | 0.010 | | 0.030 | |
| L | 0.4 | | 1.27 | 0.016 | | 0.050 | |
| K | 0° (min.)8° (max.) | | | | | | |

OUTLINE AND MECHANICAL DATA





47/

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

ST PRODUCTS ARE NOT DESIGNED OR AUTHORIZED FOR USE IN: (A) SAFETY CRITICAL APPLICATIONS SUCH AS LIFE SUPPORTING, ACTIVE IMPLANTED DEVICES OR SYSTEMS WITH PRODUCT FUNCTIONAL SAFETY REQUIREMENTS; (B) AERONAUTIC APPLICATIONS; (C) AUTOMOTIVE APPLICATIONS OR ENVIRONMENTS, AND/OR (D) AEROSPACE APPLICATIONS OR ENVIRONMENTS. WHERE ST PRODUCTS ARE NOT DESIGNED FOR SUCH USE, THE PURCHASER SHALL USE PRODUCTS AT PURCHASER'S SOLE RISK, EVEN IF ST HAS BEEN INFORMED IN WRITING OF SUCH USAGE, UNLESS A PRODUCT IS EXPRESSLY DESIGNATED BY ST AS BEING INTENDED FOR "AUTOMOTIVE, AUTOMOTIVE SAFETY OR MEDICAL" INDUSTRY DOMAINS ACCORDING TO ST PRODUCT DESIGN SPECIFICATIONS. PRODUCTS FORMALLY ESCC, QML OR JAN QUALIFIED ARE DEEMED SUITABLE FOR USE IN AEROSPACE BY THE CORRESPONDING GOVERNMENTAL AGENCY.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2013 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com



DocID5866 Rev 3 8/8